# RENESAS

### HS40xx

High-Performance Relative Humidity and Temperature Sensor with Digital Output

The HS40xx series is a highly accurate, fully calibrated automotive-grade relative humidity and temperature sensor. While the HS400x devices come in a standard package with open air inlet, the HS401x devices feature a hydropic membrane, making it dust resistant and waterproof with IP67 rating. Both sensor versions, waterproof and nonwaterproof, are available in two different accuracy classes, HS40x1 and HS40x3. The MEMS sensor features a proprietary sensor-level protection, ensuring high reliability and long-term stability.

Integrated calibration using a NIST traceable and verified production setup that is calibrated to ISO/IEC 17025 standards and temperature-compensation logic provides fully corrected RH and temperature values via a standard I<sup>2</sup>C output. No user calibration of the output data is required.

The high accuracy, fast measurement response time, and long-term stability combined with the small package size makes the HS40xx series ideal for a wide number of applications ranging from portable devices to products designed for harsh environments.

The HS40xx series digital sensor accurately measures relative humidity and temperature levels. The measured data is internally corrected and compensated for accurate operation over a wide range of temperature and humidity levels – user calibration is not required.

The ultra-low power consumption, micro-Watt, makes the HS40xx the ideal choice for portable and remote applications.

### **Physical Characteristics**

- Supply voltage: 1.71V to 3.6V
- Operating temperature: -40°C to +125°C
- $\approx 2.50 \times 2.50 \times 0.90$  mm DFN-style 8-LGA package

### **Product Image**

#### **Features**

- Humidity range: 0% to 100%RH
- Industrial grade, JEDEC qualified, -40°C to +125°C
- Automotive grade, AEC-Q100 qualified, Grade 2, -40°C to +105°C
- NIST traceability for relative humidity and temperature
- Hydrophobic membrane, IP67 rating (HS401x)
- Digital I<sup>2</sup>C output with CRC checksum
- RH accuracy: ±1.5%RH, typical (HS40x1)
- Temperature accuracy: ±0.2°C, typical (HS40x1,  $-10^{\circ}$ C to  $+80^{\circ}$ C)
- 14-bit resolution: 0.04%RH, typical
- Independent programmable resolution settings: 8, 10, 12, 14 bits
- Fast RH response time: 4 seconds time constant, typical
- Very low current consumption: 0.3µA average (8 bit resolution, 3.3V supply), 0.62µA average (14-bit resolution, 3.3V supply), one RH and temperature measurement per second
- Excellent stability against aging and volatile compounds
- Highly robust protection from harsh environmental conditions and mechanical shock

#### **Applications**

- Climate control systems
- Instrumentation
- Home appliances
- Weather stations
- Building automation
- HVAC systems
- Medical equipment
- Data logging systems



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<span id="page-3-6"></span>1. "NC" stands for not connected.

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## <span id="page-4-0"></span>**2. Specifications**

### <span id="page-4-1"></span>**2.1 Absolute Maximum Ratings**

*Caution:* The absolute maximum ratings are stress ratings only. Stresses greater than those listed below can cause permanent damage to the device. Functional operation of the HS40xx at absolute maximum ratings is not implied. Exposure to absolute maximum rating conditions might affect device reliability.

<span id="page-4-3"></span>

<b>Parameter</b>	<b>Conditions</b>	Minimum	Maximum	Unit
Supply Voltage		$-0.3$	3.6	
Storage Temperature Range	l Recommended 0 to 60°C_	-40	125	$\sim$ ◡

**Table 1. Absolute Maximum Ratings for HS40xx Sensors**

### <span id="page-4-2"></span>**2.2 Recommended Operating Conditions**

*Important:* The HS40xx series sensors are optimized to perform best in the more common temperature and humidity ranges of 10°C to 50°C and 20% RH to 80% RH, respectively. If operated outside of these conditions for extended periods, especially at high humidity levels, the sensors may exhibit an offset. In most cases, this offset is temporary and will gradually disappear once the sensor is returned to normal temperature and humidity conditions. The amount of the shift and the duration of the offset vary depending on the duration of exposure and the severity of the relative humidity and temperature conditions [\[1\]](#page-4-5). The time needed for the offset to disappear can also be decreased by using the procedures described in section [4.](#page-7-0)

<span id="page-4-4"></span>



<span id="page-4-5"></span>1. At  $T_A = +25^{\circ}C$ ,  $V_{DD} = +1.71V$  to  $+3.6V$  unless otherwise specified.

## <span id="page-5-0"></span>**3. Humidity and Temperature Sensor Performance**

### <span id="page-5-1"></span>**3.1 Humidity Sensor Specification**

#### Table 3. Humidity Sensor Specification,  $T_A = +25^{\circ}C$ ,  $V_{DD} = 1.71V$  to 3.6V

<span id="page-5-3"></span>

1. Monotonic increases from 10% to 90% RH after sensor has been stabilized at 50% RH.

2. For more information, see section [3.3.](#page-6-0)

3. Initial value to 63% of total variation. Response time depend on system airflow.

### <span id="page-5-2"></span>**3.2 Temperature Sensor Specification**

#### Table 4. Temperature Sensor Specification, T<sub>A</sub> = +25°C, V<sub>DD</sub> = 1.71V to 3.6V

<span id="page-5-4"></span>

1. For more information, see section [3.4.](#page-6-1)

2. Initial value to 63% of total variation. Response time depends on system thermal mass and air flow.

3. Temperature accuracy can be optimized for specified supply voltages upon request.

### <span id="page-6-0"></span>**3.3 Humidity Sensor Accuracy Graphs**

The typical relative humidity sensor accuracy tolerances are shown in the following figures.

90

70



<span id="page-6-2"></span>



<span id="page-6-4"></span>**Figure 5. HS40x3 RH Accuracy Tolerance at 25°C Figure 6. HS40x3 RH Accuracy over Temperature**



 $±2.5$ 

 $±2.0$ 

 $±3.0$ 

 $±2.0$ 

<span id="page-6-3"></span>



<span id="page-6-5"></span>

### <span id="page-6-1"></span>**3.4 Temperature and Sensor Accuracy Graphs**



<span id="page-6-6"></span>**Tolerance**

<span id="page-6-7"></span>

## <span id="page-7-0"></span>**4. Conditioning**

After soldering or prolonged storage outside the nominal storage conditions, a conditioning routine must be applied to ensure high sensor accuracy. Not following this routine will result in a slowly disappearing offset in the relative humidity readings. When a relative humidity sensor is exposed to the high heat associated with the soldering process, the sensor element tends to dry out. To avoid an offset in the relative humidity readings, the sensor element must be rehydrated after the soldering process.

Recommended rehydration process:

- A relative humidity of 75% RH at room temperature for at least 12 hours, or
- A relative humidity of 40% to 50% RH at room temperature for 3 to 5 days

To avoid relative humidity reading offset after prolonged storage outside the *[recommended storage conditions,](#page-24-0)* use the following procedure to recondition the humidity sensor.

- 1. Bake at a temperature of 100°C with a humidity < 10% RH for 10 to 12 hours.
- 2. Rehydrate the sensor at a humidity of 75% RH and a temperature between 20°C to 30°C for 12 to 14 hours.

## <span id="page-7-1"></span>**5. PCB Layout Guidelines**

When designing the PCB, undesired heat transfer paths to the HS40xx series must be minimized. Excessive heat from other components on the PCB will result in inaccurate temperature and relative humidity measurements. As such, **solid metal planes for power supplies should be avoided in the vicinity of the sensor** since these will act as thermal conductors. To further reduce the heat transfer from other components on the board, openings can be milled into the PCB as shown in [Figure 9.](#page-7-2)



<span id="page-7-2"></span>**Figure 9. Milled PCB Openings for Thermal Isolation**

## <span id="page-8-0"></span>**6. Application Circuit**



**Figure 10. HS40xx Application Circuit – Top View**

## <span id="page-8-3"></span><span id="page-8-1"></span>**7. Sensor Interface**

The HS40xx series sensor uses a digital l<sup>2</sup>C-compatible communication protocol. To accommodate multiple devices, the protocol uses two bi-directional open-drain lines: the Serial Data Line (SDA) and the Serial Clock Line (SCL). Pull-up resistors to  $V_{DD}$  are required. Several slave devices can share the bus; however, only one master device can be present on the line.

#### <span id="page-8-2"></span>**7.1 I 2C Features and Timing**

The HS40xx series sensor operates as a slave device on the I<sup>2</sup>C bus with support for 100kHz and 400kHz bit rates. Each transmission is initiated when the master sends a 0 START bit (S), and the transmission is terminated when the master sends a 1 STOP bit (P). These bits are exclusively transmitted while the SCL line is high.

<span id="page-8-4"></span>

**Figure 11. Timing Diagram**

<span id="page-9-3"></span>

#### **Table 5. I 2C Timing Parameters**

<span id="page-9-4"></span>1. Combined LOW and HIGH widths must equal or exceed the minimum SCL period.

### <span id="page-9-0"></span>**7.2 Sensor Slave Address**

The HS40xx series default I<sup>2</sup>C address is 54 $_{\rm HEX}$  The device will respond only to this 7-bit address.

#### <span id="page-9-1"></span>**7.3 I 2C Communication**

The sensor transmission is initiated when the master sends a 0 START bit (S). The transmission is terminated when the master sends a 1 STOP bit (P). These bits are only transmitted while the SCL line is HIGH (see [Figure](#page-9-2)  [12](#page-9-2) for waveforms).

Once the START condition has been set, the SCL line is toggled at the prescribed data rate, clocking subsequent data transfers. Data on the SDA line is always sampled on the rising edge of the SCL line and must remain stable while SCL is HIGH to prevent false START or STOP conditions.



**Figure 12. START and STOP Condition Waveform**

<span id="page-9-2"></span>After the START bit, the master device sends the 7-bit slave address (see sectio[n 7.2\)](#page-9-0) to the HS40xx, followed by the read/write bit, which indicates the transfer direction of any subsequent data. This bit is set to 1 to indicate a read from slave to master or set to 0 to indicate a write from master to slave.

All transfers consist of 8 bits and a response bit: 0 for Acknowledge (ACK) or 1 for Not Acknowledge (NACK). After the ACK is received, another data byte can be transferred or the communication can be stopped with a STOP bit.

The HS40xx series sensors are equipped with different commands to configure the chip and to perform measurement as described in [Table 6.](#page-10-1)

<span id="page-10-1"></span>

#### **Table 6. Commands Code and Description**

The Hold and No-hold commands are described in section [7.4,](#page-10-0) and the read and write register commands are described in section [7.7.](#page-17-0) The HS40xx sensor can measure only temperature or both humidity and temperature as described in [Table 7.](#page-10-2) Both options return fully calibrated measurements that can be converted to humidity and temperature readings using the equations in section [7.4.3.](#page-12-0) To soft reset the sensor, see section [7.10.](#page-22-0)

#### **Table 7. Measurement Command Modes**

<span id="page-10-2"></span>

#### <span id="page-10-0"></span>**7.4 Measurements and Commands**

There are two types of measurement commands:

- 1. Hold Measurement commands The HS40xx series sensor holds the SCL line low during the measurement and releases the SCL line when the measurement is complete. This lets the master know exactly when the measurement has finished. Using this mode will prevent the master from communicating with any other slave until the measurement is complete. Note that the minimum frequency for the SCL clock in this mode is 200kHz.
- 2. No-hold Measurement commands The HS40xx series sensor does not hold the SCL line low, and the master is free to initiate communication with other slaves while the chip is performing the measurement. To obtain the measurement data, the master must request the result from the chip after the expected conversion time which depends on the measurement resolution as summarized in section [7.4.4.](#page-13-0) There is no minimum clock frequency when in this mode.

#### <span id="page-11-0"></span>**7.4.1 Performing a Hold Measurement**

A hold measurement sequence consists of the following steps, as displayed in [Figure 13.](#page-11-2) The minimum SCL clock frequency in this mode is 200kHz.

- 1. Wake up the HS40xx series sensor from sleep mode by sending its  $I<sup>2</sup>C$  address with a write bit and initiate a measurement by sending the desired hold measurement command.
- 2. Change the direction of communication by sending a start bit, the HS40xx I<sup>2</sup>C address, and a read bit. The SCL line is held low by the sensor during the measurement process, which prevents the master from initiating any communications with other slaves on the bus.

Once the requested measurement is completed by the HS40xx series sensor, the SCL line is released and the chip waits for the SCL clock signal to send the results. The sensor will then transmit the requested measurement data on the bus for the master to capture and enters sleep mode again after 20µs.



**Figure 13. Typical Hold Measurement Sequence for a Humidity and Temperature Command**

#### <span id="page-11-2"></span><span id="page-11-1"></span>**7.4.2 Performing a No-Hold Measurement**

A no-hold measurement sequence consists of the following steps, as displayed in [Figure 14.](#page-12-1)

- 1. Wake up the HS40xx series sensor from sleep mode by sending its I 2C address with a write bit and initiate a measurement by sending the desired no-hold measurement command.
- 2. To read the result from the HS40xx series sensor, the master has to send the chip its I<sup>2</sup>C address and a read bit. If the measurement is completed and the result is ready, the chip will send an ACK bit and start to send the result over the bus and then enter sleep mode again after 20us. If the measurement is still in progress, the chip will send a NACK bit and the master will need to try to read the result again.



**Figure 14. Typical No-Hold Measurement Sequence for a Humidity and Temperature Command**

#### <span id="page-12-1"></span><span id="page-12-0"></span>**7.4.3 Calculating Humidity and Temperature Output**

As indicated in [Table 7,](#page-10-2) the measurement data can be either two or four bytes long depending on whether a temperature measurement or a humidity and temperature measurement was initiated. The most significant bit of the reading is sent first followed by the least significant bits. The humidity and temperature measurements are always scaled up to a 14-bit value regardless of the selected resolution of the sensor. The relative humidity (in percent) and the temperature (in degrees Celsius) are obtained as follows:

The relative humidity (in percent) and the temperature (in degrees Celsius) are calculated with [Equation 1](#page-12-2) and [Equation 2,](#page-12-3) respectively.

<span id="page-12-3"></span><span id="page-12-2"></span>
$$
Humidity \left[ \%RH \right] = \frac{Humidity[13:0]}{2^{14} - 1} * 100
$$
 **Equation 1**

Temperature 
$$
[^{\circ}C] = \frac{Temperature [13:0]}{2^{14} - 1} * 165 - 40
$$
 Equation 2

#### <span id="page-13-0"></span>**7.4.4 Measurement Conversion Times**

The HS40xx series sensors are designed to have relatively fast conversion times. The conversion time depends on the resolution of the measurement and the command type (temperature or humidity and temperature). [Table 8](#page-13-2) summarizes the conversion times for different resolutions.

<span id="page-13-2"></span>

#### **Table 8. Conversion Times**

<span id="page-13-4"></span>1. Assuming the same resolution settings for both humidity and temperature measurements.

#### <span id="page-13-1"></span>**7.4.5 CRC Checksum Calculation**

<span id="page-13-3"></span>An 8-bit CRC checksum is transmitted after each measurement so that the user can check for data corruption during communications if desired. The properties of the CRC algorithm used are summarized in [Table 9,](#page-13-3) and the CRC is based on all 4 bytes of measurement data (2 bytes of humidity data followed by 2 bytes of temperature data). For temperature-only measurements, the 2 bytes of humidity data are set to be all zeros for the CRC calculation.





#### <span id="page-14-0"></span>**7.5 Periodic Measurement Mode**

The HS40xx sensors can also be configured to measure at regular intervals without user intervention, and the process to enable this mode is described in section [7.8.2.](#page-19-2) In this mode, the user can read the latest relative humidity / temperature data by issuing a data fetch sequence, which consists of sending the HS40xx I<sup>2</sup>C address with a read bit. The sensor will then send the latest measurement result over the I 2 C bus. The data fetch sequence is displayed in [Figure 15.](#page-14-2)



**Figure 15. Sequence to Retrieve the Latest Results in Periodic Measurement Mode**

<span id="page-14-2"></span>The frequency of the periodic measurements can be set using the configuration registers. Section [7.7](#page-17-0) describes how these registers are accessed, and section [7.8.2](#page-19-2) provides the register settings needed to configure and activate the periodic measurements.

When the periodic measurement mode is active, the only commands the chip will respond to are the data fetch command, and a command to stop the periodic measurements. The sensor will not enter sleep mode while in periodic measurement mode. The command to stop periodic measurements is issued by sending the I $^{\rm 2}$ C address with a write bit, followed by the command 0x30, as shown in [Figure 16.](#page-14-3) Once the periodic measurements have been stopped, the chip returns to sleep and is ready to accept all valid I<sup>2</sup>C commands.



**Figure 16. Sequence to Stop Periodic Measurements**

#### <span id="page-14-3"></span><span id="page-14-1"></span>**7.6 Alert Feature**

The HS40xx sensors have an optional Alert feature that can be configured in the following two ways:

- 1. The Alert pin can be used to indicate when a measurement is active in periodic measurement mode. This is the default behavior of the Alert pin upon power-up.
- 2. The Alert pin can be used to trigger an interrupt on the system microcontroller so an appropriate action can be taken if the temperature or humidity is outside of the desired limits.

These features are described in the following two sub-sections.

#### <span id="page-15-0"></span>**7.6.1 Alert Pin – Measurement Active**

The default behavior of the Alert pin is to indicate when a measurement is active if periodic measurement mode is used. Upon power-up, the Alert pin will have a logic high level. When periodic measurement mode is activated, the Alert pin will have a logic low level between measurements and a logic high during measurements. This behavior is shown in [Figure 17,](#page-15-2) and the Alert pin will exhibit this functionality when the temperature and humidity alerts are disabled (see [Table 13\)](#page-20-0).

If periodic measurement mode is not active, the Alert pin will remain at a logic high level.



**Figure 17. Alert Pin Function**

#### <span id="page-15-2"></span><span id="page-15-1"></span>**7.6.2 Alert Pin – Humidity and Temperature Threshold Detection**

The Alert pin can also be configured to send a signal when a humidity / temperature threshold is exceeded, and the system needs to respond. In this mode, the Alert feature has a programmable threshold, polarity, and hysteresis, and can apply to both temperature and humidity measurements. An example of the functionality of the Alert feature is displayed i[n Figure 18.](#page-16-0)





**Figure 18. Alert Pin Functionality Example**

<span id="page-16-0"></span>The registers used to enable the Alert feature and the temperature / humidity thresholds are shown in [Table 11.](#page-19-3) When the Alert feature is enabled for either humidity or temperature in periodic measurement mode, an additional status byte will precede the measurement values. The format of the bits are returned from the HS40xx sensor when any Alert is enabled as shown in [Figure 19.](#page-16-1)



**Figure 19. Data Returned from HS40xx when the Alert Feature is Enabled in Periodic Measurement Mode**

<span id="page-16-1"></span>

#### **Table 10. Alert Status Bits**

<span id="page-17-1"></span>

### <span id="page-17-0"></span>**7.7 Accessing Configurable HS40xx Registers**

The HS40xx measurement settings can be changed by accessing the appropriate configuration registers and altering their values. This can be done by issuing a Write Register command. A Read Register command is also available to read the configuration register values. These commands are described in this section, and the configuration registers and settings are described in section [7.8.](#page-19-0)

While accessing specific configuration bits in any register, all the other bits in that register must be left unchanged. To write a specific bit/bits in a register, the process is as follows:

- 1. Read the entire configuration register using the sequence described in section [7.7.1.](#page-18-0)
- 2. Mask the register such that only the required bits are changed according to the configuration parameters in section [7.8.](#page-19-0)
- 3. Write the new register back to the appropriate address using the Write Register command sequence described in section [7.7.2.](#page-18-1)

All configuration registers will be reset to their default values if the power supply to the chip is cut off.

#### <span id="page-18-0"></span>**7.7.1 Read Register Command**

A Read Register sequence consists of the following steps, as illustrated in [Figure 20.](#page-18-2)

- 1. Wake up the HS40xx series sensor from sleep mode by sending its  $I^2C$  address with a write bit and initiate a Read Register command by sending the command 0xA7.
- 2. Send the address of the register to be read.
- 3. Change the direction of communication by sending the HS40xx I<sup>2</sup>C address and a read bit. The chip will send the data stored in this register, after which the master replies with a NACK and a STOP bit.



**Figure 20. Read Register Command Sequence**

#### <span id="page-18-2"></span><span id="page-18-1"></span>**7.7.2 Write Register Command**

A Write Register sequence consists of the following steps, as illustrated in [Figure 21.](#page-18-3)

- 1. Wake up the HS40xx series sensor from sleep mode by sending its  $I^2C$  address with a write bit and initiate a Write Register command by sending the command 0xA6.
- 2. Send the address of the register to write.
- 3. Send the data to be stored in this register followed by a STOP bit.



<span id="page-18-3"></span>**Figure 21. Write Register Command Sequence**



### <span id="page-19-0"></span>**7.8 Configuration Bits**

#### <span id="page-19-1"></span>**7.8.1 Setting the Measurement Resolution**

The HS40xx can be configured to perform measurements at different humidity and temperature resolutions by using the Read and Write Register commands with the appropriate register address. There are four separate resolution settings for the temperature and humidity measurements, as summarized i[n Table 11.](#page-19-3)



<span id="page-19-3"></span>

#### <span id="page-19-2"></span>**7.8.2 Periodic Measurement Settings**

<span id="page-19-4"></span>The registers that are used to activate and configure the periodic measurement settings are shown in [Table 12.](#page-19-4)

#### **Table 12. Periodic Measurement Settings**



#### **Table 13. Alert Feature Settings**

<span id="page-20-0"></span>





### <span id="page-21-0"></span>**7.9 Reading the Sensor ID Number**

The sensor ID is a 32-bit number that can be used to identify a specific device. Each sensor has a unique ID that can be used for traceability. The sequence to read the sensor ID is as follows:

- 1. Wake up the HS40xx series sensor from sleep mode by sending its  $I^2C$  address with a write bit and initiate a Read Sensor ID command by sending the command 0xD7.
- 2. Change the direction of communication by sending the HS40xx  $I^2C$  address and a read bit. The SCL line is held low by the sensor while it retrieves the ID from internal memory to prevent data corruption. The sensor takes approximately 10µs to retrieve the ID from internal memory.

3. Once the request is completed by the HS40xx, the SCL line is released and the chip waits for the SCL clock signal to send the results. The sensor will then transmit the 4-byte sensor ID on the bus for the master to capture, MSB first.

The command sequence to read the sensor ID is displayed in [Figure 22.](#page-22-1)



**Figure 22. Read Sensor ID Command Sequence**

#### <span id="page-22-1"></span><span id="page-22-0"></span>**7.10 Resetting the Sensor**

With the command 0xFE, it is possible to soft reset the HS40xx. The reset will affect all writeable registers and sets them back to the default value. To use this command, ensure that the following conditions are met:

- 1. If the user initiates a measurement, they must read the measurement data before issuing the soft reset command.
- 2. If the user has the HS40xx in Periodic Measurement Mode, they must escape the "Periodic Measurement Mode" before issuing the soft reset command. This can be achieved by sending the "Stop Periodic Measurement" command.

To reset the sensor, use the following sequence:

- 1. Wake up the HS40xx series sensor from sleep mode by sending its I2C address with a write bit.
- 2. Send the soft reset command 0xFE.

After sending the reset command, wait for at least 500ms before starting to communicate with the HS40xx. The sensor will behave like it was just powered on.

## <span id="page-23-0"></span>**8. Soldering Information**

This section discusses soldering considerations for the HS40xx.

Standard reflow ovens can be used to solder the HS40xx series sensor to the PCB. The peak temperature  $(T<sub>p</sub>)$ for use with the JEDEC J-STD-020D standard soldering profile is 260°C. For manual soldering, the contact time must be limited to 5 seconds at up to 350°C. In either case, if solder paste is used, it is recommended to use "no-clean" solder paste to avoid the need to wash the PCB.

When a relative humidity sensor is exposed to the high heat associated with the soldering process, the sensor element tends to dry out. To avoid an offset in the relative humidity readings, the sensor element must be rehydrated after the soldering process. Care must also be taken when selecting the temperatures and durations involved in the soldering process to avoid irreversibly damaging the sensor element.

The recommended soldering profile for a lead-free (RoHS-compliant) process is shown below.



**Figure 23. Recommended Soldering Profile**

<span id="page-23-1"></span>*Important:* Ensure this temperature profile is measured at the sensor itself. Measuring the profile at a larger component with a higher thermal mass means the temperature at the small sensor will be higher than expected.

For manual soldering, the contact time must be limited to **5 seconds** with a maximum iron temperature of **350°C**.

In either case, a board wash after soldering is **not** recommended. Therefore, if a solder paste is used, it is strongly recommended that a **"no-clean"** solder paste is used to avoid the need to wash the PCB.

After soldering, the recommended rehydration process in section [4](#page-7-0) should be performed; otherwise, there may be an initial offset in the relative humidity readings, which will slowly disappear as the sensor get exposed to ambient conditions.

## <span id="page-24-0"></span>**9. Storage and Handling**

**Recommendation:** Once the sensors are removed from their original packaging, store them in metal-in antistatic bags.

Avoid using polyethylene antistatic bags as they may affect sensor accuracy.

The nominal storage conditions are 10°C to 50°C and humidity levels within 20% to 60%RH. If stored outside of these conditions for extended periods of time, the sensor readings may exhibit an offset. The sensor can be reconditioned and returned to its calibration state by applying the procedure described in section [4.](#page-7-0)

## <span id="page-24-1"></span>**10. Quality and Reliability**

The HS40xx series is available as a qualified product for consumer and industrial market applications. All data specified parameters are guaranteed if not stated otherwise.

## <span id="page-24-2"></span>**11. Package Outline Drawings**

The package outline drawings are located at the end of this document and are accessible from the Renesas website. The package information is the most current data available and is subject to change without revision of this document.

## <span id="page-24-3"></span>**12. Marking Diagram**



- Line 1: Sensor type (for example, 4011)
- Line 2:
	- First character: Year (for example,  $3 = 2023$ )
	- Second character: Week code (for example,  $X = 31$ )
	- Third and fourth character: Test Release Sequence Number

## <span id="page-24-4"></span>**13. Ordering Information**



## <span id="page-25-0"></span>**14. Revision History**





#### **Package Outline Drawing**

RENESAS

#### Package Code: LVG8D3 8-LGA 2.50 x 2.50 x 0.90 mm Body, 0.50mm Pitch PSC-4861-03, Revision: 03 Date Created: Aug 27, 2024



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